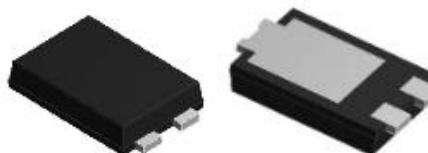


10A, 200V Low Forward Voltage Schottky Rectifier

FEATURES

- Planar MOS schottky barrier diode
- Low forward voltage drop
- Low profile - typical body height 1.1 mm
- Moisture sensitivity: level 1, per J-STD-020
- High temperature soldering guaranteed: 260°C/10 seconds
- RoHS compliant
- Halogen-free according to IEC 61249-2-21 definition

TO-277B



**RoHS
COMPLIANT**

**HALOGEN
FREE**



MECHANICAL DATA

- Case: TO-277B
- Case material: molding compound meets UL 94V-0 flammability rating

TYPICAL APPLICATION

General purpose use in AC to DC wave rectification for SMPS, lighting, adapter, charger, home appliance, office equipment and telecommunication.

MAXIMUM RATINGS

$T_A=25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Value	Unit
Repetitive Peak Reverse Voltage	V_{RRM}	200	V
Average Forward Rectified Current	$I_{F(AV)}$	10	A
Peak Forward Surge Current (8.3 ms single half sine-wave superimposed on rated load)	I_{FSM}	160	A
Operating Junction Temperature Range	T_J	-55 to +150	°C
Storage Temperature Range	T_{STG}	-55 to +150	°C

ELECTRICAL CHARACTERISTICS

$T_A=25^\circ\text{C}$ unless otherwise noted

Parameter	Test Conditions	Symbol	Value		Unit
			Typ.	Max.	
Forward Voltage@ $I_F=10\text{A}$	$T_A=25^\circ\text{C}$	V_F	0.82	0.86	V
	$T_A=125^\circ\text{C}$		0.7	0.73	
Reverse Current @ V_{RRM}	$T_A=25^\circ\text{C}$	I_R	1	10	uA
	$T_A=125^\circ\text{C}$		0.6	5	mA
Typical Thermal Resistance (junction to ambient)		$R_{\theta JA}$	102		°C/W

10A, 200V Low Forward Voltage Schottky Rectifier

RATINGS AND CHARACTERISTIC CURVES

$T_A=25^\circ\text{C}$ unless otherwise noted

FIG.1: Forward Output Current Derating Curve

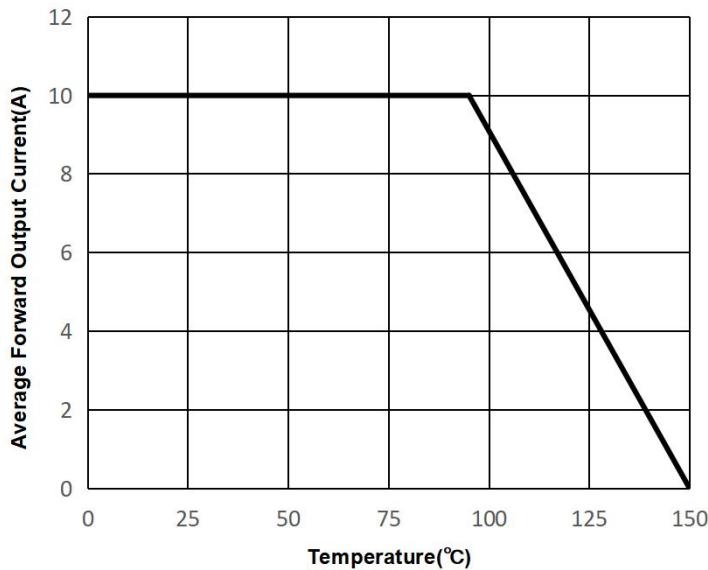


FIG.2: Maximum Non-Repetitive Peak Forward Surge Current

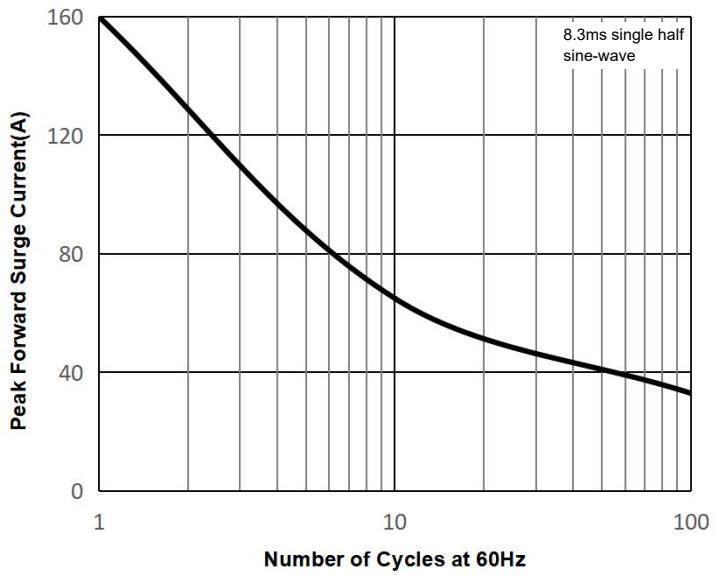


FIG.3: Typical Forward Characteristics

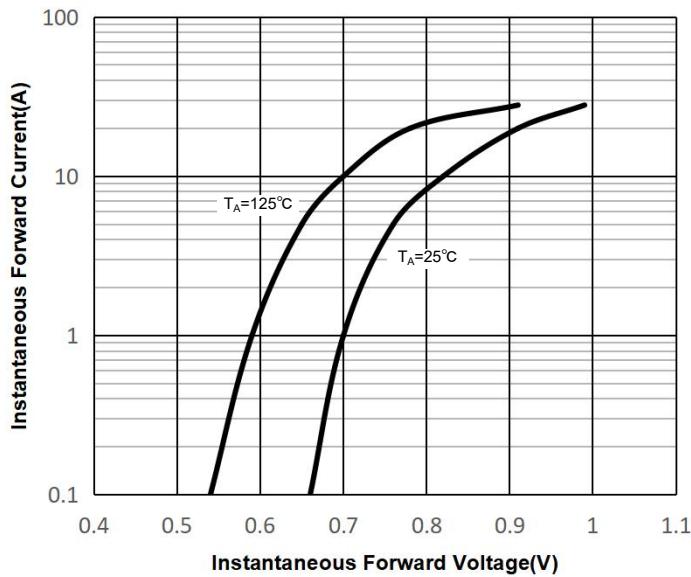
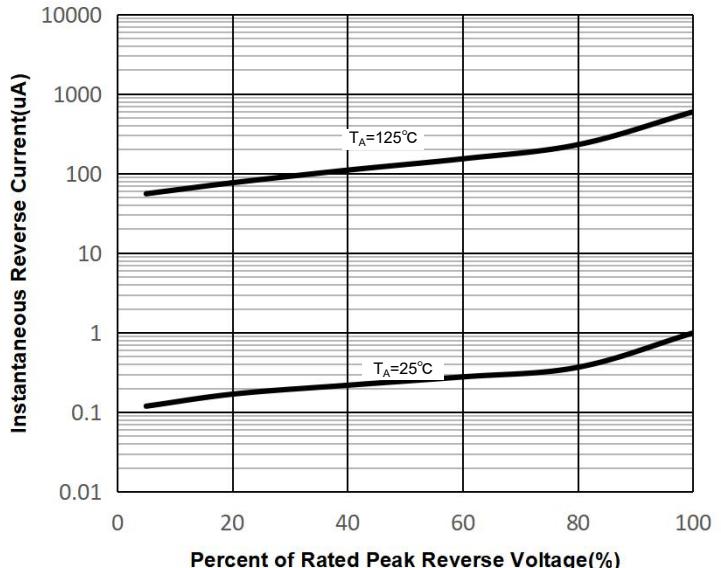
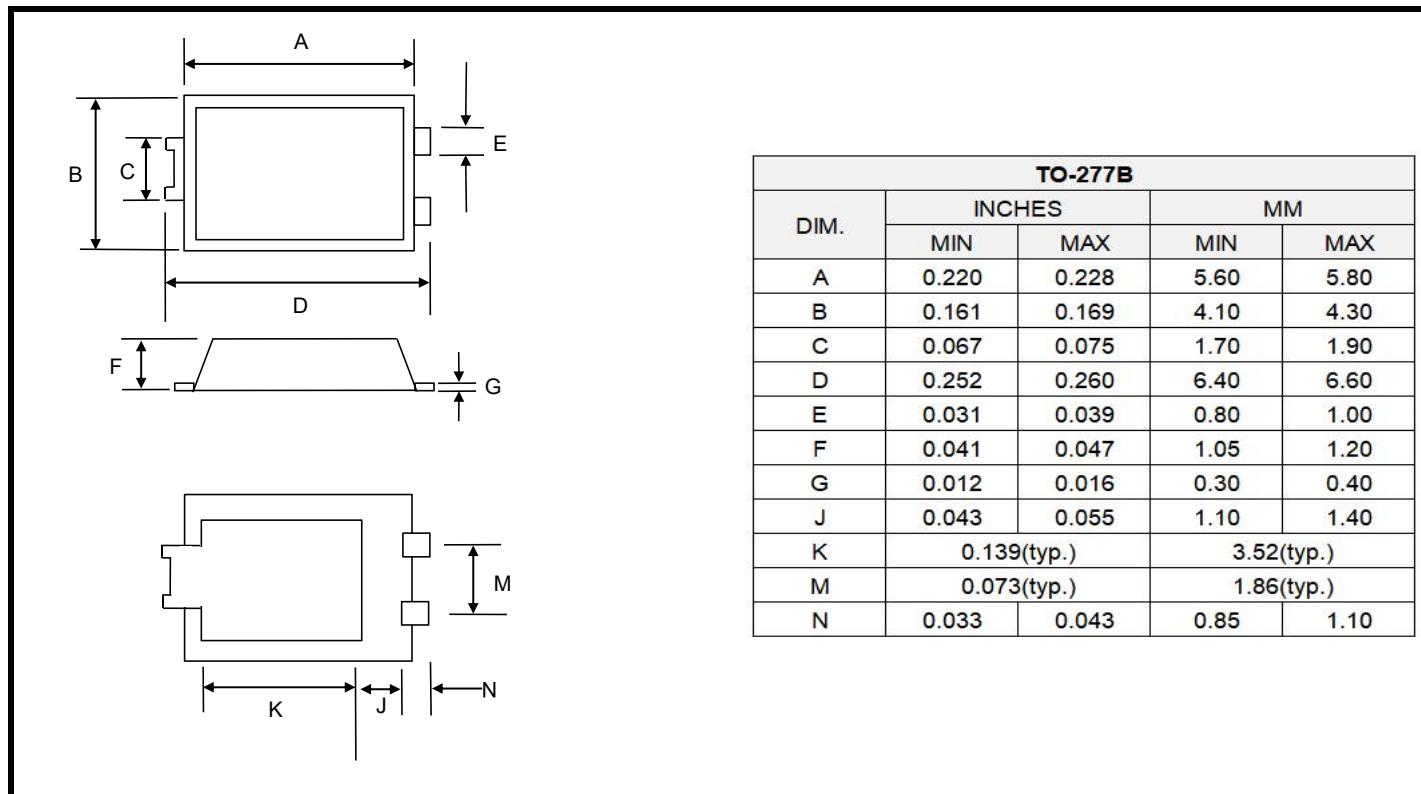


FIG.4: Typical Reverse Characteristics



10A, 200V Low Forward Voltage Schottky Rectifier

PACKAGE OUTLINE DIMENSIONS



The diagram illustrates the physical dimensions of the TO-277B package. It consists of two parts: a top view and a side view. The top view shows a rectangular package with lead spacing (A), height (B), lead thickness (C), lead height (E), and lead pitch (D). The side view shows the thickness of the lead frame (F) and the overall height of the package (G). The bottom view shows the footprint of the package with lead spacing (K), lead thickness (J), and lead height (M).

TO-277B				
DIM.	INCHES		MM	
	MIN	MAX	MIN	MAX
A	0.220	0.228	5.60	5.80
B	0.161	0.169	4.10	4.30
C	0.067	0.075	1.70	1.90
D	0.252	0.260	6.40	6.60
E	0.031	0.039	0.80	1.00
F	0.041	0.047	1.05	1.20
G	0.012	0.016	0.30	0.40
J	0.043	0.055	1.10	1.40
K	0.139(typ.)		3.52(typ.)	
M	0.073(typ.)		1.86(typ.)	
N	0.033	0.043	0.85	1.10

PACKING INFORMATION

Package	Reel(PCS)	Inner Box(PCS)	Carton(PCS)
TO-277B	5,000	10,000	80,000